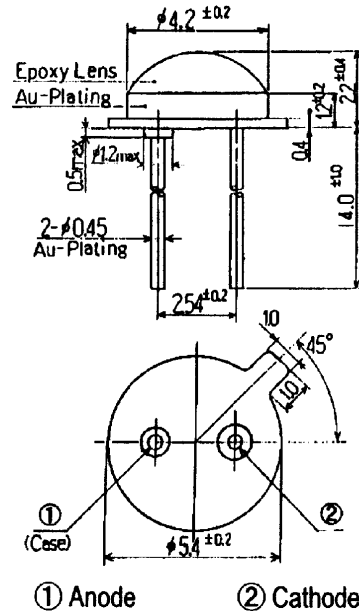


## Preliminary data

Color	Type	Technology	Case
Infrared	1 mm <sup>2</sup> power chip	AllnGaP/GaAIAs	TO-46 with epoxy

Features: High output power,  
wide beam angle,  
high reliability

Applications: Optical switches,  
optical sensors



## Maximum Ratings\*

T<sub>amb</sub> = 25°C, unless otherwise specified

Parameter	Test conditions	Symbol	Value	Unit
Forward current (DC)		I <sub>F</sub>	500	mA
Reverse voltage	I <sub>R</sub> =10 μA	V <sub>R</sub>	5	V
Power dissipation		P <sub>D</sub>	180	mW
Operating temperature range		T <sub>amb</sub>	-20 to +80	°C
Storage temperature range		T <sub>stg</sub>	-30 to +100	°C

## Optical and Electrical Characteristics\*\*

T<sub>amb</sub> = 25°C, unless otherwise specified

Parameter	Test conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	I <sub>F</sub> = 100 mA	V <sub>F</sub>		1.4	1.6	V
Forward voltage	I <sub>F</sub> = 300 mA	V <sub>F</sub>		1.65	1.85	V
Radiant power**	I <sub>F</sub> = 100 mA	Φ <sub>e</sub>	21	30		mW
Radiant power*	I <sub>F</sub> = 300 mA	Φ <sub>e</sub>	65	90		mW
Peak wavelength	I <sub>F</sub> = 100 mA	λ <sub>p</sub>	860	875	890	nm
Spectral bandwidth at 50%	I <sub>F</sub> = 100 mA	Δλ <sub>0.5</sub>		50		nm
Viewing angle	I <sub>F</sub> = 100 mA	φ		180		deg.
Switching time	I <sub>F</sub> = 100 mA	t <sub>r</sub> , t <sub>f</sub>		50		ns

\*Proper heat sinking is required to maintain correct device operation and reliability at currents higher than 100 mA. \*\*Package without heatsink.